

U.S. Sales 9029 Owensmouth Avenue Canoga Park, CA 91304 Phone: (818) 701-7240 Fax: (818) 701-7217

SPECIFICATION

PART NO.: LT12W3-4D-UDE3-WD

4.6mm CYLINDRIC LED LAMP

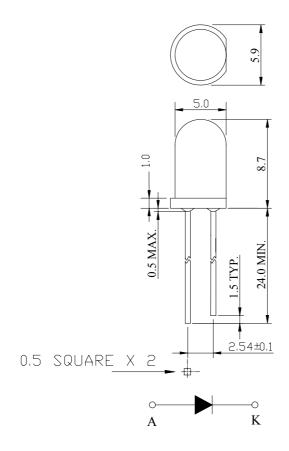




Approved by	Checked by	Prepared by
Sam	Yang	Min Bao

Description

This white lamp is made with InGaN/Sapphire chip and water clear epoxy resin.



Notes:

- 1. ALL DIMENSIONS ARE IN mm.
- 2. TOLERANCE IS \pm 0.25mm UNLESS OTHERWISE NOTED.

Description

	LED Chip			
Part No.	Material	Emitting Color	Lens Color	
LT12W3-4D-UDE3-WD	InGaN/Sapphire	White	Water clear	

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LT12W3-4D-UDE3-WD

Absolute Maximum Ratings at Ta=25

Parameter	Symbol	Rating	Unit
Power Dissipation	PD	120	mW
Reverse Voltage	VR	5	V
D.C. Forward Current	If	30	mA
Reverse (Leakage) Current	Ir	50	μA
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	If(Peak)	100	mA
Operating Temperature Range	Topr	-25 to +85	
Storage Temperature Range	Tstg	-40 to +100	
Lead Soldering Temp.(1.6mm from body) for 5 seconds	Tsol	260	
Electrostatic discharge	ESD	6000	V

Electrical and Optical Characteristics:

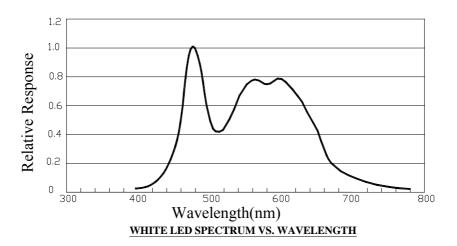
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Luminous Intensity	Iv	If=20mA	370	850		mcd
Forward Voltage	Vf	If=20mA		3.2	4.0	V
Correlated Colour Temperature	ССТ	If=20mA	5000		6000	°K
Reverse (Leakage) Current	Ir	Vr=5V			50	μΑ
Viewing Angle	2 1/2	If=20mA		100		deg
Spectrum Line Halfwidth	Δλ	If=20mA				nm

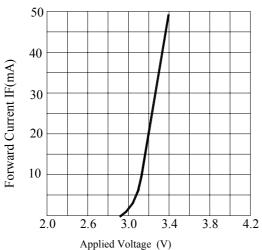
NOTE: THE DATAS TESTED BY IS TESTER

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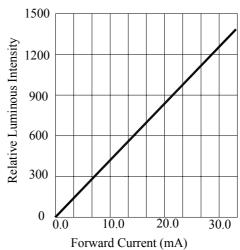


Typical Electrical / Optical Characteristics Curves:

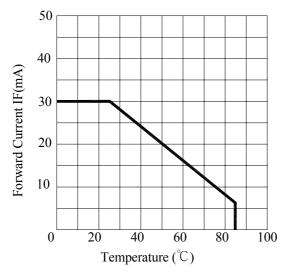




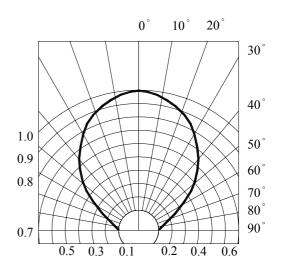
FORWARD CURRENT VS.APPLIED VOLTAGE



FORWARD CURRENT VS. LUMINOUS INTENSITY



FORWARD CURRENT VS. AMBIENT TEMPERATURE



RADIATION DIAGRAM

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4.6mm CYLINDRIC LED LAMP

Precautions:

TAKE NOTE OF THE FOLLOWING IN USE OF LED

1. Temperature in use

Since the light generated inside the LED needs to be emitted to outside efficiently, a resin with high light transparency is used; therefore, additives to improve the heat resistance or moisture resistance (silica gel, etc) which are used for semiconductor products such as transistors cannot be added to the resin.

Consequently, the heat resistant ability of the resin used for LED is usually low; therefore, please be careful on the following during use.

Avoid applying external force, stress, and excessive vibration to the resins and terminals at high temperature. The glass transition temperature of epoxy resin used for the LED is approximately 120-130 .

At a temperature exceeding this limit, the coefficient of liner expansion of the resin doubles or more compared to that at normal temperature and the resin is softened.

If external force or stress is applied at that time, it may cause a wire rupture.

2. Soldering

Please be careful on the following at soldering.

After soldering, avoided applying external force, stress, and excessive vibration until the products go to cooling process (normal temperature), <Same for products with terminal leads>

(1) Soldering measurements:

Distance between melted solder side to bottom of resin shall be 1.6mm or longer.

- (2) Solder dip: Preheat: 90 max. (Backside of PCB), Within 60 secondsSolder bath: 260 ±5 (Solder temperature), Within 5 seconds
- (3) Soldering iron: 350 max. (Temperature of soldering iron tip), Within 3 seconds

3. Insertion

Pitch of the LED leads and pitch of mounting holes need to be same

Others

Since the heat resistant ability of the LED resin is low, SMD components are used on the same PCB, please mount the LED after adhesive baking process for SMD components. In case adhesive baking is done after LED lamp insertion due to a production process reason, make sure not to apply external force, stress, and excessive vibration to the LED and follow the conditions below.

Baking temperature: 120 max. Baking time: Within 60 seconds

If soldering is done sequentially after the adhesive baking, please perform the soldering after cooling down the LED to normal temperature.

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4.6mm CYLINDRIC LED LAMP

ENCASED TYPE



LEDTECH ELECTRONICS CORP.

PART NO :LTXXXX-XX

Q'TY : PCS

LOT NO :XXXXXXXXX

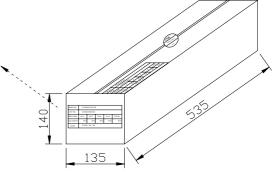
DATE : BIN CODE:



QUANTITY: 40 PACKETS

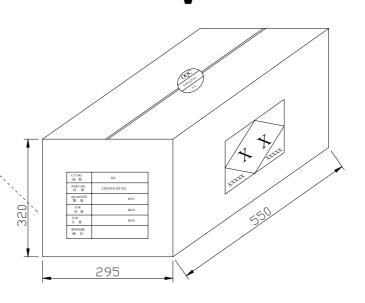
TOTAL: 8,000 PCS

PART NO.	LXXXXX-XX				
LOT NO.	xxxxxxxxx				
BIN CODE	Xx X	Xx X	Xx X	Xx X	TOTAL
QUANTITY	PCS PCS PCS PCS PC				PCS
DATE	XXXX, XX, XX				



OUTER CARTON QUANTITY: 4 BOX TOTAL: 32,000 PCS

C/T NO. 箱 號	XX
PART NO. 料 號	LXXXXX-XX-XX
QUANTITY 數 量	PCS
N.W. 净 重	KGS
G.W. 毛 重	KGS
REMARK 備 註	



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